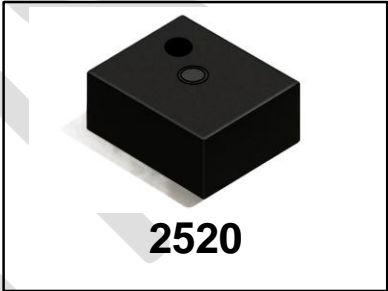


**BFX3006G**

**5250 MHz  
BAW Filter**



**MAXIMUM RATING:**

- Input Power Level: + 28dBm
- Operating Temperature: -40°C to +85°C
- Storage Temperature: -40°C to +125°C
- Moisture Sensitivity Level: 3
- ESD Class 500V (HBM) Class 1000V (CDM)
- Small Form Factor 2.5mm x 2.0mm x 1.0mm

**Applications**

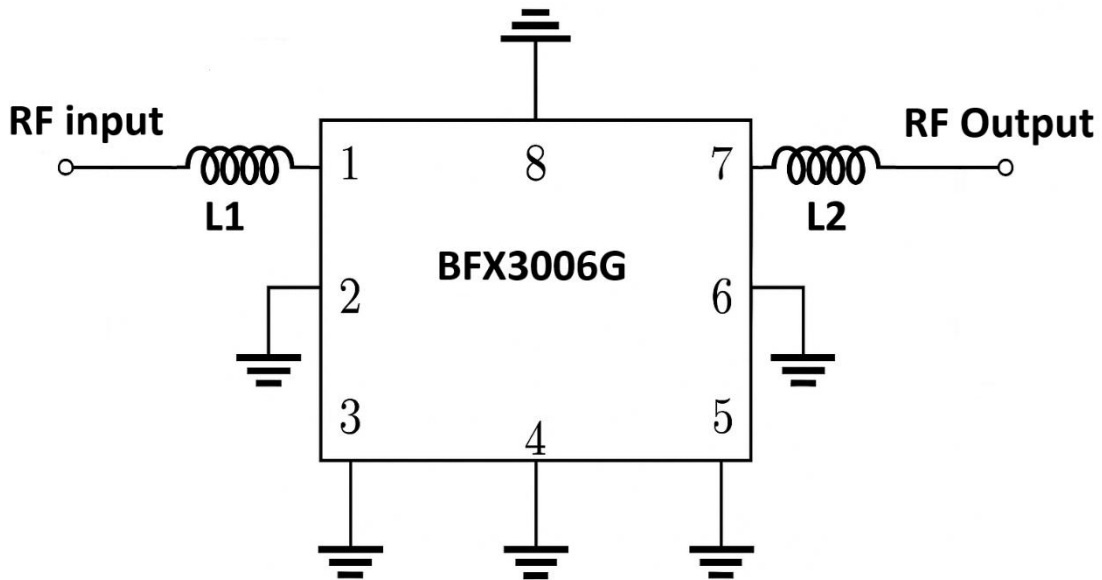
- Wi-Fi tri band routers, integrated cable modem
- Wi-Fi tri band access points
- LTE/LAA small cells

**ELECTRICAL CHARACTERISTICS:**

Item	Unit	Min.	Typ.	Max.
<b>Center Frequency and Bandwidth</b>	MHz	5170	5250	5330
<b>Insertion Loss (5170 - 5330)</b>	dB		1.3 <sup>(1)</sup>	2.0
<b>Amplitude Ripple</b>	dB		0.6	0.7
<b>Attenuation</b>				
30 ~ 2700 MHz	dB	35	36	
3300 ~ 3700 MHz	dB	37	38	
5490 ~ 5835 MHz	dB	54	57	
5945 ~ 6425 MHz	dB	46	50	
6525 ~ 7125 MHz	dB	43	46	
7500 ~ 11000 MHz	dB	30	32	
<b>Return Loss</b>	dB	12	20 <sup>(1)</sup>	
<b>Load Impedance</b>	Ω		50	
<b>Power Handling (11ax, MCS10, 80MHz, PAR 11dB)</b>	dBm			28
<b>2<sup>nd</sup> Harmonic (Po=28dBm @25c)</b>	dBm/MHz		-43	
<b>3<sup>rd</sup> Harmonic (Po=28dBm @25c)</b>	dBm/MHz		-91	

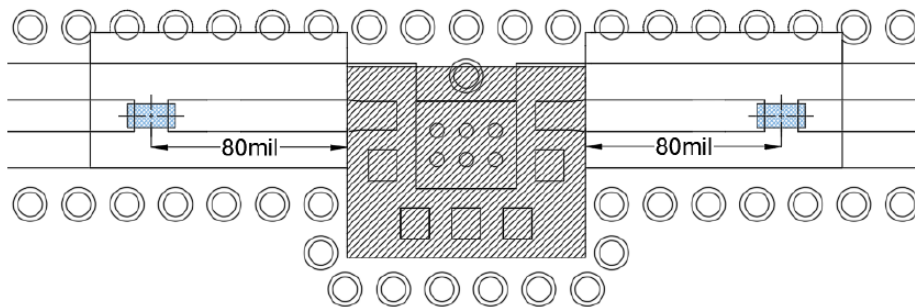
(1) Averaged over specified frequency at 25C.

## EVB Schematic



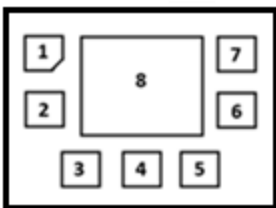
Reference Des.	Value	Description	Manufacturer	Manufacturer	Part Number
L1	1.4nH	Chip inductor, 0201, $\pm 0.05\text{nH}$	Murata	Murata	LQP03HQ1N4W02
L2	1.4nH	Chip inductor, 0201, $\pm 0.05\text{nH}$	Murata	Murata	LQP03HQ1N4W02

## EVB Layout

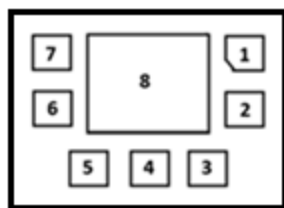


Notes: Center ground pad via: 6mil; outer via: 10mil

## Pin definition



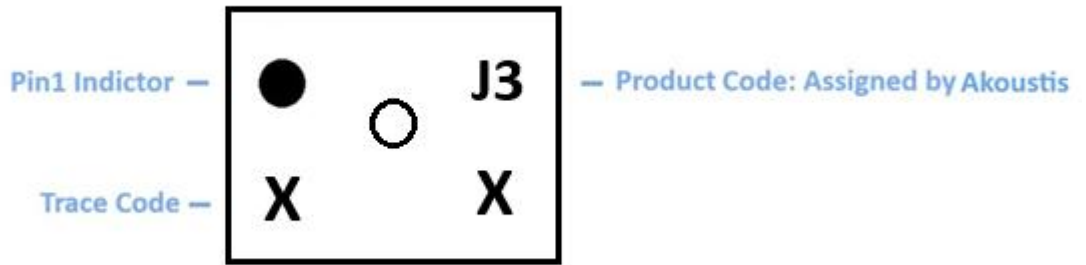
TOP View



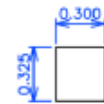
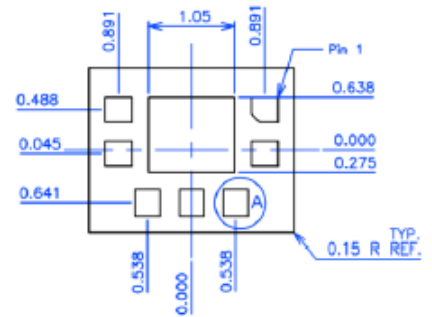
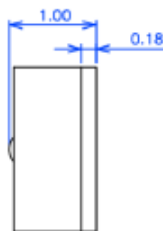
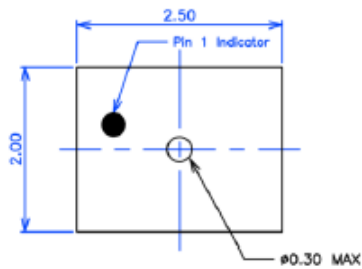
Bottom View

Pin	Name	Description
1	RF In	(High power input)
7	RF Out	Antenna TX
2, 3, 4, 5, 6, 8,	GND	Ground

# Typical Part Marking



# Outline Drawing

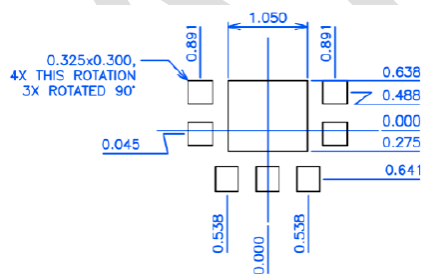


DETAIL A  
PAD  
SCALE: 2x  
3X THIS ROTATION  
4X ROTATED 90°  
PIN 1 CHAMFER 0.150 X 45°

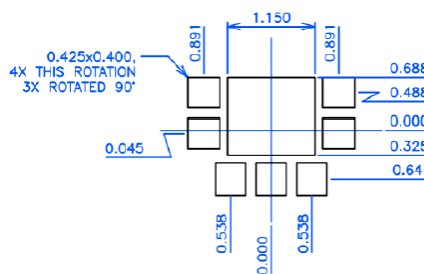
NOTES:  
1. Terminal Finish:  
Electroless Ni/Electroless Pd/Immersion Au

Notes:  
- All Units are in mm unless otherwise stated  
- General Tolerance:  
Linear X.XXX =  $\pm 0.050$ mm  
X.XX =  $\pm 0.10$ mm

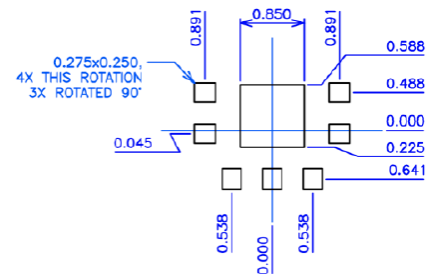
# PCB Footprint



Recommended PCB  
Metal Top View



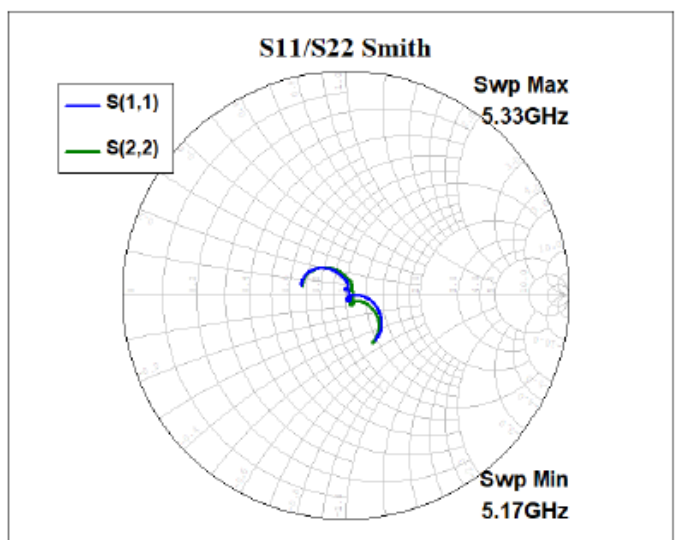
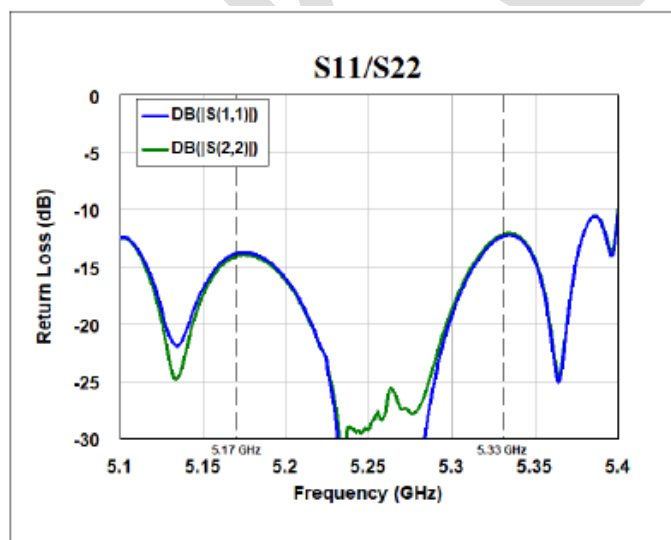
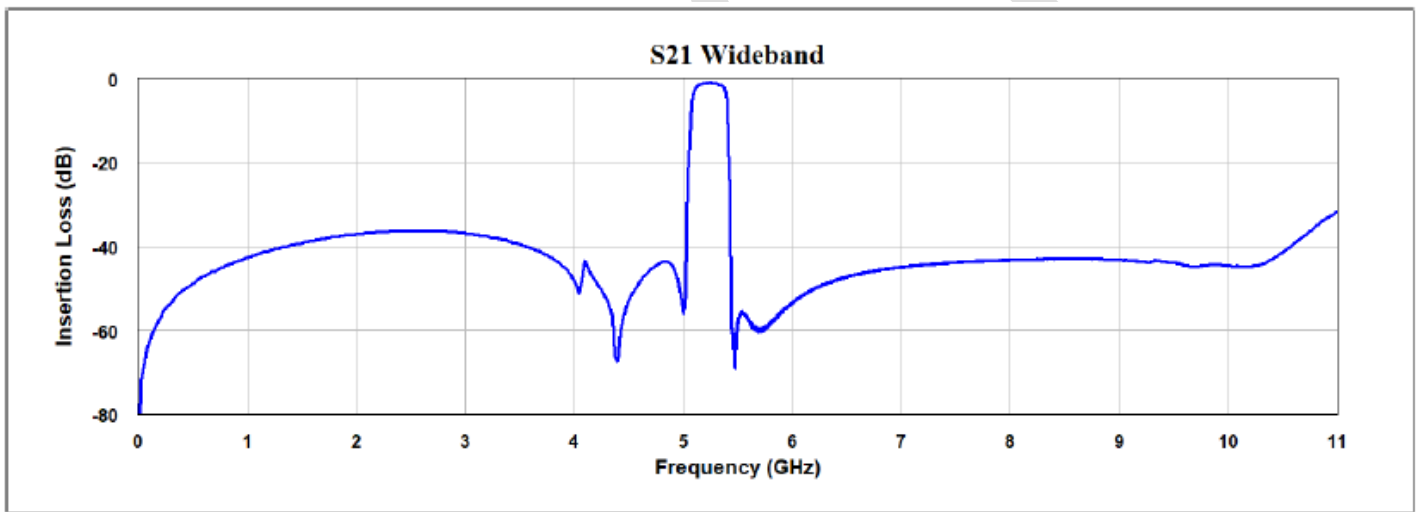
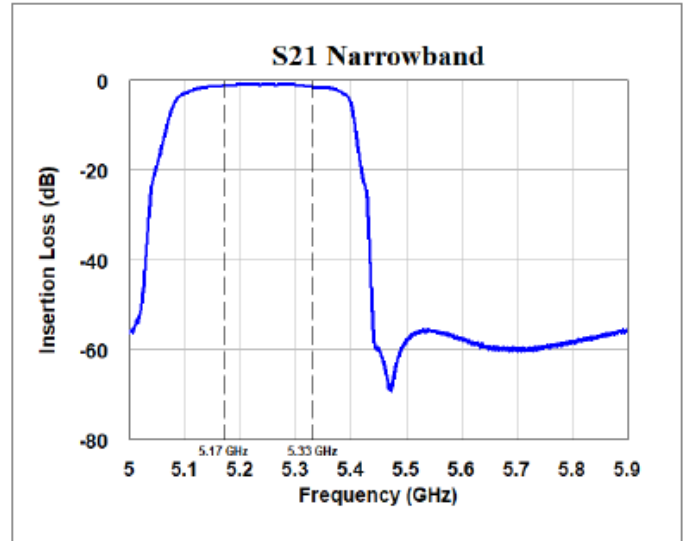
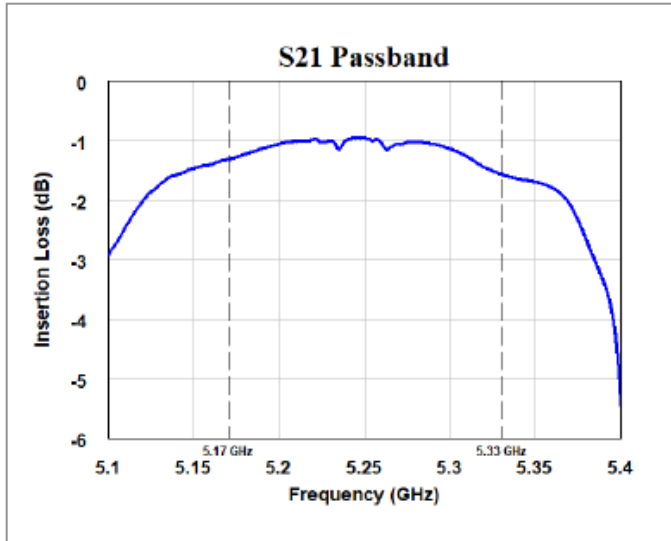
Recommended  
Solder Mask Opening  
Top View



Recommended Stencil  
Pattern Top View

Unit: mm

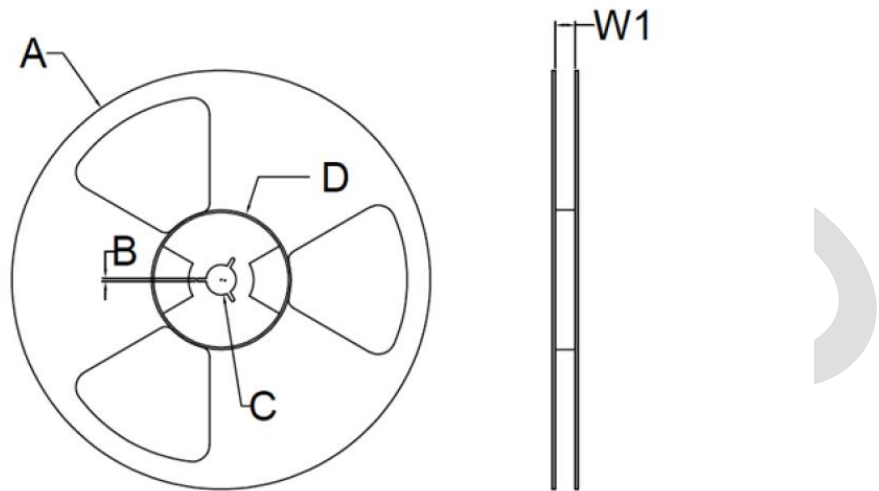
## Performance Plots



# Reel Dimension

Reel Count

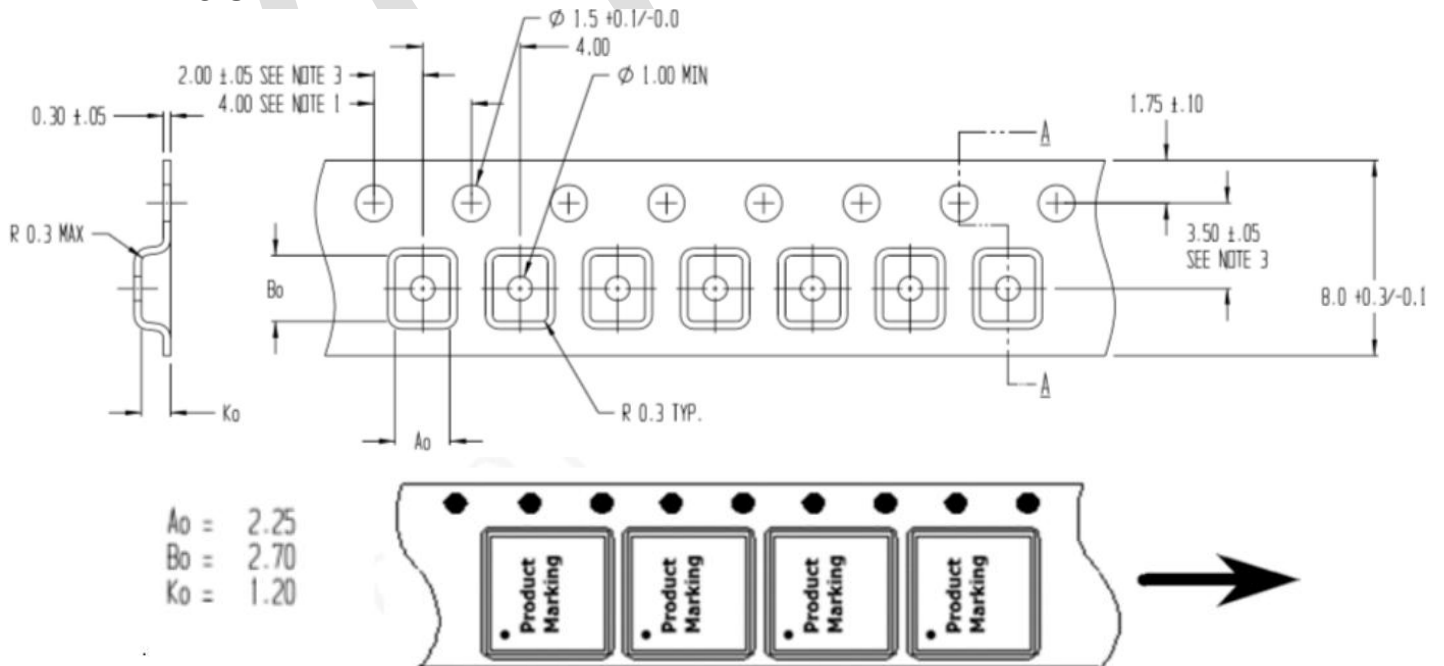
7" = 2500



Reel Dimensions						
Reel Size	Tape Width	A	B	C	D	W1 *measured at hub
7 Inch	8 mm	180+0/-2.0 mm	2.0mm +/-0.5	13.0+0.5 / -0 mm	60.0+/- 2.0 mm	8.40+1.5 / -0 mm
	12 mm	180+0/-2.0 mm	2.0mm +/-0.5	13.0+0.5 / -0 mm	60.0+/- 2.0 mm	12.40+2.0 / -0 mm
	16 mm	180+0/-2.0 mm	2.0mm +/-0.5	13.0+0.5 / -0 mm	60.0+/- 2.0 mm	16.40+2.0 / -0 mm
13 Inch	8 mm	330+/- 2.0 mm	2.0mm +/-0.5	13.0+0.5 / -0.2 mm	102 +/- 2.0 mm	8.8+2.0 / -0 mm
	12 mm	330+/- 2.0 mm	2.0mm +/-0.5	13.0+0.5 / -0.2 mm	102 +/- 2.0 mm	12.8+2.0 / -0 mm
	16 mm	330+/- 2.0 mm	2.0mm +/-0.5	13.0+0.5 / -0.2 mm	102 +/- 2.0 mm	16.8+2.0 / -0 mm

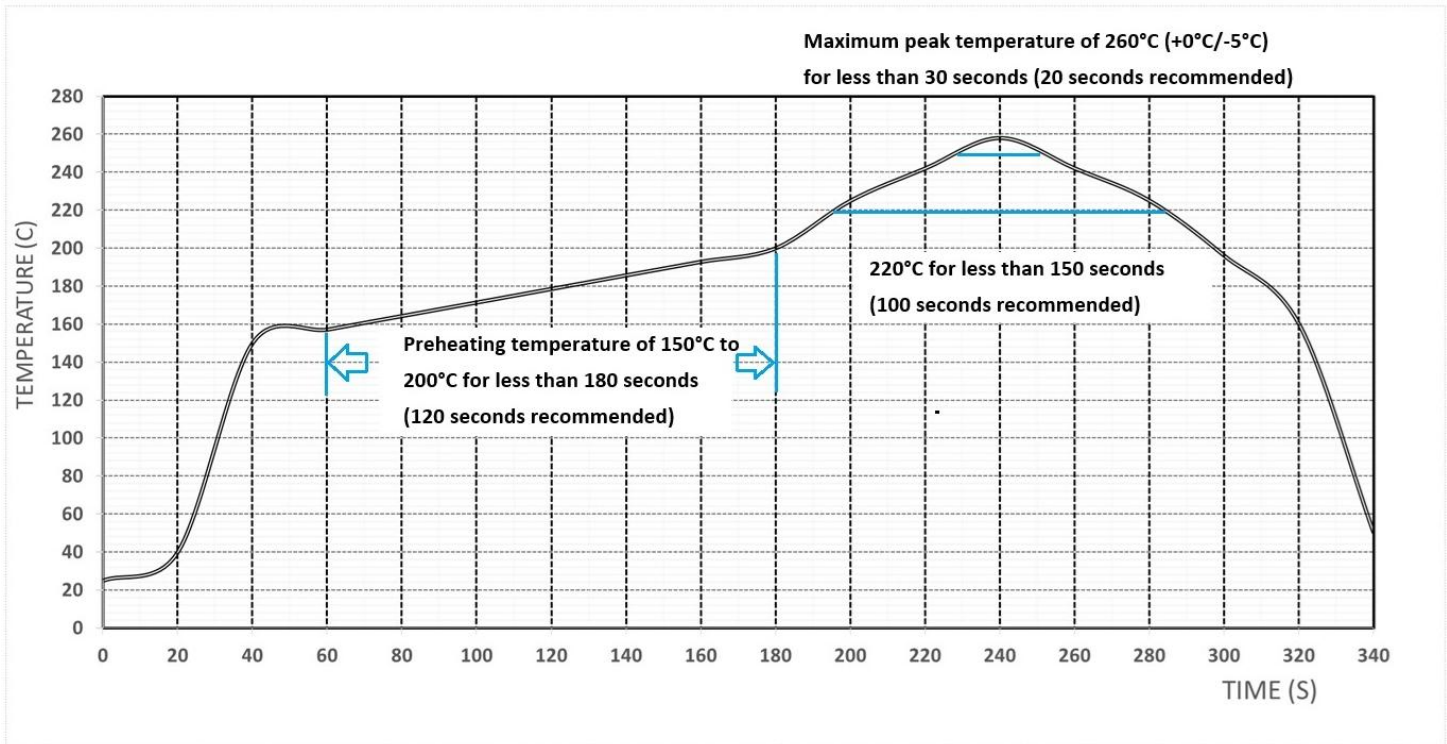
Note: 7 Inch Reel Only Has One Opening

## TAPE DIMENSION



## RECOMMENDED REFLOW PROFILE

1. Preheating shall be fixed at 150°C~200°C for 90~180 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 90~130 seconds
4. Heating 20 seconds for 245~260°C peak (min. 10sec, max 30sec).
5. Time: 2 times.



## RECOMMENDED SMT Pick Up Nozzle Size

AKTS BFX3006G a 2520 package size with a vent hole gel size at the center of the top surface package. As such, in order to have an optimum SMT pick up, we would recommend to using a nozzle size with the **inner** diameter of 1.20 mm to 1.30 mm.